1. Introduction

The utility of using nanosize layered silicate (organically modified clays) as reinforcements in organic polymers to obtain polymer/clay nanocomposites has been well reported over the past decade [1]. Good improvement in properties can be achieved in such materials due to the high surface contact area of the reinforcing filler which causes high strength, modulus and other properties at low clay loading level usually (<5 wt%). Our work is aimed to study epoxy-hectorite nanocomposites due to the wide applications of epoxy prepolymer as structural matrices and adhesives in electronic, electrical products and other items [1]. Therefore, epoxy prepolymer is some of the most commonly studied polymers in the preparation of nanocomposites with layered silicates because the polar epoxy monomers can easily diffuse into the clay galleries [2, 3]. In fact, the matrix/filler type system used, the extent of filler adhesion to the matrix, and the levels of dispersion of the filler throughout the matrix degree are among the parameters which mainly determine any enhancement of a particular property of nanocomposites [4]. Moreover, the nature of the surfactant as well as the curing conditions, especially the temperature is expected to play a role in the exfoliation process [2]. In this respect, Kornman et al. [5] reported recently that a long chain alkylamine, having a chain of more than eight carbon atoms, could significantly result in an exfoliated clay structure. Furthermore, a balance between the intragallery and extragallery polymerization rates is essential to exfoliate the clay in an epoxy system [6]. According to the literature data [7–12], there are three different methods to synthesize polymer-clay nano-
composites: melt intercalation process for thermoplastic polymers, solution method, where both organoclay and polymer precursors are dissolved in a polar organic solvent and in situ polymerization technique. However, the latter one was found to be the most effective technique for thermoset polymer matrix nanocomposites [6].

On the other hand, the commonly used techniques for processing clay-epoxy nanocomposites are direct mixing and solution mixing [13]. However, these techniques produce intercalated or intercalated/exfoliated composites rather than exfoliated composites. According to Vaia et al. [14], the degree of exfoliation can be improved through the aid of conventional shear devices such as extruders, mixers, ultrasonicators, etc.

In this paper, ultrasonication was used as a means of applying external shearing forces to disperse and exfoliate the silicate clay layers in the epoxy matrix. The procedure consisted firstly of swelling the clays in the curing agent due to its low viscosity allowing better diffusion into the intragallery space. The epoxy prepolymer was added, and under these conditions, the occurrence of a complete exfoliation was expected. It is worthwhile to point out that the nanosilicate used to carry out this study was a natural hectorite (called HECT) because literature data on its application in the epoxy-nanocomposites system are rather scarce.

2. Experimental

2.1. Materials used

The clay was a natural hectorite (called HECT) supplied by Süd-Chemie (from Germany) whose trade name is Optigel SH. It was a sodic silicate containing mainly magnesium and lithium according to the following chemical formula:

\[ \text{Na}_{0.32} (\text{M}_{2.82}\text{Li}_{0.18})\text{Si}_4\text{O}_{10}(\text{OH})_2 \]

The cation exchange capacity (CEC) of the clay was 120 meq/100 g.

The organic system was based on epoxy/amine, the prepolymer diglycidyl ether of bisphenol A (DGEBA) is manufactured by Vantico (France) under the grade name DGEBA LY 556 with the following characteristics: an \( n \) (polymerization degree) value of 0.15 and a number-average molecular weight of 382.6 g/mol. The curing agent is an aliphatic diamine with a polyoxypropylene backbone supplied by Huntsman (Belgium) under the trade name Jeffamine D2000 with a number-average molecular weight of 1970 g/mol.

2.2. Organoclay preparation

The method of organoclay preparation is similar to that used by Le Pluart et al. [7]. The silicates were exchanged with octadecylammonium ions at 80°C with two CEC’s (cation exchange capacity) amine/clay ratio. 0.2 moles of octadecylamine were dissolved in 20 l of 0.01 N of hydrochloric acid solution (based on deionised water). The solution was stirred at 80°C for three hours. Then, 100 g of clay were added to the solution and the whole was stirred at the same temperature for three more hours. The solution was filtered and the silicates were further washed 6 times more with hot deionised water and once with a hot ethanol: water (1:1) mixture so that no chloride was detected up on adding 0.1 M aqueous AgNO₃.

The resulting organoclay was then dried at 85°C for 36 hours and kept dry in a vacuum box. After modification, the organomodified silicates are called HECTC18.

2.3. Preparation of epoxy-nanocomposites

The silicate clays 5 per hundred resin (5 phr) and the curing agent were initially sonicated at 80°C for 10 min using an ultrasonic processor device at a frequency of 20 kHz, an amplitude of 6 \( \mu \)m and electric power of 130 watts. The temperature of 80°C corresponded to the first curing temperature of the reactive agents. The epoxy prepolymer was then added to the mixture, and the whole was stirred for 15 min more. Then, the blend was poured into a steel mold and cured for 2 hours at 80°C, this was followed by postcuring for 3 hours at 120°C. The stoichiometric mass ratio of DGEBA to D2000 was calculated, and the value was 2.65 according to the the diamine functionality, which was itself determined by chlorydric acid in dioxane (3.54) [15].

2.4. Nanocomposite characterization

2.4.1. Wide angle X-ray diffraction

Wide angle X-ray diffraction (WAXD) measurements were performed at room temperature on a SIEMENS D500 diffractometer (Germany) with a Brentano Bragg geometry goniometer with CuKα.
radiation (wavelength = 1.54 Å), operating at 40 kV and 30 mA. The diffraction patterns were collected between angles 2θ of 1 and 70° for unmodified HECT and 1–10° for modified HECT, at a scanning rate and step size of 5°/min and 0.02°, respectively.

2.4.2. Transmission electronic microscopy
The different nanocomposites samples were ultramicrotomed with a diamond knife on a Leica (Bannock-burn IL) Ultracut UCT microtome at ~70°C to give sections with a nominal thickness of 70 nm. The sections were transferred from dry conditions (~70°C) to carbon-coated 200-mesh Cu grids. The transmission electronic microscopy (TEM) images were obtained at 120 kV under low dose conditions, with a Philips CM120 electron microscope (Netherlands).

2.4.3. Tensile testing
The stress – strain parameters were measured according to NF T 51-034 method, on a tensile machine 2/M which belongs to the MTS Society (France). The specimen has the shape H3 having the dimensions 2×4×10 mm, while the measurements were carried out at room temperature with a crosshead speed of 5 mm/min. An average value of 5 samples was determined.

The theory of rubber elasticity [16] was used to relate the state of deformation at the molecular level to the externally applied deformation. In the case of uniaxial deformation, the true stress (force divided by the deformed area) is defined, for dry networks formed in the bulk state as Equation (1):

\[ \sigma = \rho \frac{RT}{M_c} \left( \lambda^2 - \lambda^{-1} \right) \]

where \( \sigma \) is the true stress, \( \rho \) is the network density, \( T \) is the absolute temperature, \( M_c \) is the average molecular weight of chains between crosslinks and \( \lambda \) is the extension ratio defined as the ratio of the final length of the sample in the direction of stretch to the initial length before deformation.

2.4.4. Dynamic mechanical thermal analysis
The dynamic mechanical thermal analysis of the nanocomposite properties was determined with a Rheometric Dynamic Analyzer (Paris, France). The tests were carried out in the torsion deformation mode, at a frequency of 1 Hz, with a temperature program ranging from −100 to 50°C at a heating rate of 3°C/min under a controlled strain of 0.17% corresponding to the linear portion of the viscoelastic domain of the material.

3. Results and discussion

3.1. Organophilic modification of hectorite
The X-ray diffraction spectra gathered in Figure 1 already reveals that a first peak located on the spectrum characterizes the repetition of platelet in the direction (001), i.e. d-spacing and the other peaks allow to identify the silicate host structure. Although hectorite is a natural silicate, the diffraction peaks are less resolved. The shoulder at 12.03 Å reveals the lack of platelet organization on long distances.

After the cationic exchange, the silicate surface properties are modified. Taking into account the lack of crystalline organization for pristine hectorite, it is impossible to characterize the intercalation of organic chains between hectorite platelets by WAXS (Figure 2).

The thermal stability of clay before modification, analyzed by TGA from the weight loss derivative \( (d\text{m}/dT) \) as a function of the temperature, is reported in Figure 3. Three areas of weight loss on DTG curves can be observed. The first volatile departure at temperatures lower than 150°C is associated with the vaporization of free water (between
pores and aggregates). The second area is attributed to departure of intercalated water on a temperature range included between 350 and 670°C, and for higher temperatures between 650 and 750°C, the dehydroxylation of silicates is observed [17]. In Figure 3, the thermogravimetric analysis (TGA) of clay after modification, reveals several peaks linked to a volatile departure. The low-temperature peak, located between 40 and 70°C, is associated to the vaporization of free water and water bonded to the cations by hydrogen bonds. The following decompositions are related to alkylammonium ions. It was shown previously [17], that the first decomposition step is due to adsorbed octadecylammonium ions. In fact, after the cationic exchange, some ions remain adsorbed on hydroxyl groups on platelets edges and are not intercalated between the nanoplatelets. The thermal decomposition takes place in the range to 200–350°C range. The well intercalated modifying ions show higher thermal stability and the decomposition temperature included between 350–500°C depends on interactions between different organic groups and the platelet surface. At temperatures higher than 700°C, the dehydroxylation of the silicates takes place [18]. Thus the organophilic clays display organic chains both inside galleries as intercalated species and outside platelets as adsorbed species. This later category could be a wettability aid of nanofillers for being introduced into organic medium. The cationic exchange capacity was measured from the amount of intercalated ions determined after careful washing and the value is 120 meq/100 g indicating the high intercalated ions ratio inside galleries. These results indicate clearly that the organic modification of HECT occurs by ion exchange of the sodium ions present on HECT with organic alkyl ammonium ions leading to an intercalation.

3.2. Morphology

Figures 4 and 5 show the transmission electron micrograph (TEM) images of HECT and HECTC18 nanocomposites, respectively. In Figure 5, it is observed the formation of agglomerates indicating clearly the poor dispersion of the clays in the epoxy matrix, because of the poor interactions between a polar unmodified HECT and the organic matrix. In contrast, Figure 5 illustrates a good dispersion of the clay particles and layers in the matrix resulting from the swelling of the HECTC18 in the nanocomposites, indicating a good compatibility between organophilic modified hectorite and the organic matrix [19].

3.3. Mechanical properties

Figure 6 shows the curves of the true stress as a function of \((\lambda^2 - \lambda^{-1})\) for HECT and HECTC18 nanocomposites. The general form of the curves fits a linear relationship that is described by the following equation: \(\sigma = E(\lambda^2 - \lambda^{-1})\), where \(E\) represents the slope of the curve defined as a rubber elasticity modulus [16]. In both samples, the stiffness is improved, however more pronounced in the case of HECTC18 nanocomposites. In fact, this property is increased by 16 and 55% for HECT and HECTC18 nanocomposites, respectively. This result is in agreement with that obtained by Wang et al. [20] who reported that the addition of 5 wt%
of nanoclay in epoxy amine matrix leads to an increase by twice of the rubber elasticity of the nanocomposites compared to that of the matrix. The $E$ values are reported in details in Table 1.

The stiffness, stress, strain and energy at break values of the epoxy matrix (DGEBA/D2000), HECT and HECTC18 nanocomposites are reported in details in Table 1. An increase of both the stress and the energy at break is observed in HECTC18 nanocomposite samples compared with the epoxy matrix. The increase of these two parameters could be attributed to better dispersion of organophilic nanosilicate in the nanocomposites compared to unmodified hectorite nanocomposites. These results are consistent with those obtained by TEM. When the dispersion of organoclays in the matrix DGEBA/D2000 is carried out manually, the mechanical properties do not increase significantly, compared with the results obtained with ultrasound mixing process. The improvement of mechanical properties might be linked to the state of dispersion at the micron and the nanometer scale level [7].

### 3.4. Dynamic thermal mechanical analysis

The dynamic mechanical properties of HECT and HECTC18 nanocomposites have been studied over a wide range (–100 to 50°C). The variation of $\tan\delta$ as a function of temperature for both materials is reported in Figure 7. In this figure, it is observed one relaxation peak corresponding to the mechanical transition temperature which slightly decreases in the presence of the organosilicate. According to the literature [21], this behaviour is explained in terms of a reduction of the polymer volume fraction in the presence of the filler. This means that at low temperatures, the polymer matrix by itself is responsible for a high proportion of energy dissipation, while the nanoparticles strongly absorb any energy. Moreover, the $\tan\delta$ peak seems to shift slightly to higher temperatures upon adding the nanoclay from –31 to –29°C. According to Lopez-Manchado [22], these results are due to the occurrence of a strong adhesion between the nanoclay and the matrix. This interaction reduces the mobil-

### Table 1

<table>
<thead>
<tr>
<th>Matrix DGEBA/D2000</th>
<th>$E$ [MPa]</th>
<th>$E/E_0$</th>
<th>$\sigma_r$ [MPa]</th>
<th>$\epsilon_r$ [%]</th>
<th>$W_b$ [10$^{-3}$ J]</th>
<th>$W_b/W_0$</th>
</tr>
</thead>
<tbody>
<tr>
<td>Unloaded</td>
<td>0.51</td>
<td>1</td>
<td>0.8 ± 0.05</td>
<td>69 ± 5</td>
<td>26 ± 2</td>
<td>1</td>
</tr>
<tr>
<td>HECT (5 phr)</td>
<td>0.59</td>
<td>1.16</td>
<td>0.58 ± 0.05</td>
<td>10 ± 3</td>
<td>50 ± 3</td>
<td>1.92</td>
</tr>
<tr>
<td>HECTC18 (5 phr)</td>
<td>0.79</td>
<td>1.55</td>
<td>1.03 ± 0.07</td>
<td>88 ± 3</td>
<td>118 ± 2</td>
<td>4.54</td>
</tr>
</tbody>
</table>

![Figure 6. True stress as function of $(\lambda^2 - 1^{-1})$ of DGEBA/D2000 matrix, HECT and HECTC18 nanocomposites](image1)

![Figure 7. $\tan\delta$ as a function of temperature for DGEBA/D2000 matrix, HECT and HECTC18 nanocomposites](image2)

![Figure 8. Storage modulus as a function of temperature for DGEBA/D2000 matrix, HECT and HECTC18 nanocomposites, measured at 1 Hz](image3)
ity of the rubber epoxy chains, resulting in elevated transition temperature.

Figure 8 shows the shear modulus of HECT and HECTC18 nanocomposites as a function of temperature. It is noted that the organoclay induces a slight increase in modulus value of HECTC18 nanocomposites compared with the epoxy matrix which is attributed to the interaction of epoxy and HECTC18 [23]. All the data are reported in details in Table 2.

### Table 2. Values of the shear modulus ($G'$), mechanical transition temperature ($T_m$), and tanδ of various samples based on DGEBA/D2000 matrix, HECT and HECTC18 nanocomposites recorded at 1 Hz, measured between –100 and 50°C

<table>
<thead>
<tr>
<th>Formulation codes</th>
<th>$G'$ at 25°C [MPa]</th>
<th>$T_m$ [°C]</th>
<th>tanδ</th>
</tr>
</thead>
<tbody>
<tr>
<td>DGEBA/D2000</td>
<td>1.23</td>
<td>–31</td>
<td>1.2</td>
</tr>
<tr>
<td>HECT/DGEBA/D2000</td>
<td>1.30</td>
<td>–30</td>
<td>1.1</td>
</tr>
<tr>
<td>HECTC18/DGEBA/D2000</td>
<td>4.26</td>
<td>–29</td>
<td>1.0</td>
</tr>
</tbody>
</table>

4. Conclusions

From the study, the following conclusions can be drawn. Hectorite is a natural silicate, the diffraction peaks are less resolved. The shoulder at 12.03 Å reveals the lack of platelet organization on long distances.

The modification of the surface of HECT by octadecylammonium ions to HECTC18 produces an intercalation as demonstrated by the TG/DTG thermograms. The addition of HECTC18 to the epoxy matrix in the proportion of 5 phr and the application of a sonicator as a device to ensure a good stirring leads to an exfoliation. As a result, a significant improvement of both the stress – strain parameters at break and the viscoelastic properties is observed. Finally, the HECTC18 increases considerably both the stiffness and the energy at break of the nanocomposites, although it is not easy to obtain a compromise between the two parameters. However, in the case of the nanocomposites studied, i. e. DGEBA/D2000/HECTC18, the homogeneity of the morphology results in a significant increase of both the stiffness by almost 55% and the energy at break by more than 350%.

### References


